

# **HAT1054R**

# Silicon P Channel Power MOS FET High Speed Power Switching

REJ03G1154-0300

(Previous: ADE-208-1224A)

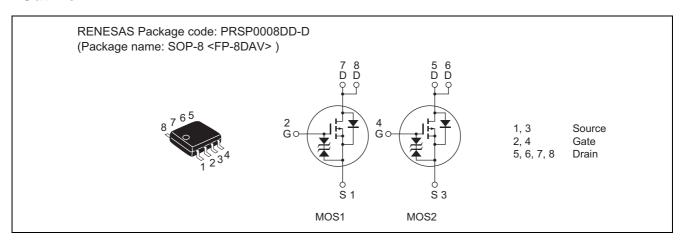
Rev.3.00

Sep 07, 2005

### **Features**

- Low on-resistance
- www.DataSheet U. Capable of 2.5 V gate drive
  - Low drive current
  - High density mounting

#### **Outline**



# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Value	Unit	
Drain to source voltage	V <sub>DSS</sub>	-20	V	
Gate to source voltage	V <sub>GSS</sub>	±12	V	
Drain current	I <sub>D</sub>	-6	A	
Drain peak current	I <sub>D (pulse)</sub> Note 1	-48	A	
Body-drain diode reverse drain current	I <sub>DR</sub>	-6	Α	
Channel dissipation	Pch Note 2	2	W	
Channel dissipation	Pch Note 3	3	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

- www.DataSheeNotes: 1. PW ≤ 10 μs, duty cycle ≤ 1%
  - 2. 1 Drive operation: When using the glass epoxy board (FR4  $40 \times 40 \times 1.6$  mm), PW  $\leq 10$  s
  - 3. 2 Drive operation: When using the glass epoxy board (FR4  $40 \times 40 \times 1.6$  mm), PW  $\leq 10$  s

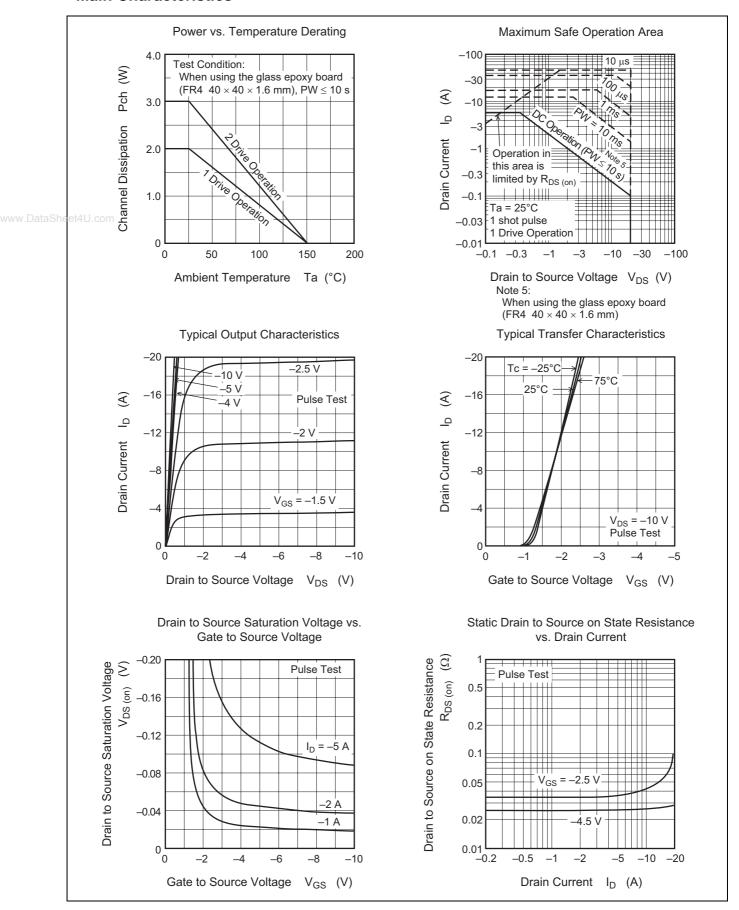
### **Electrical Characteristics**

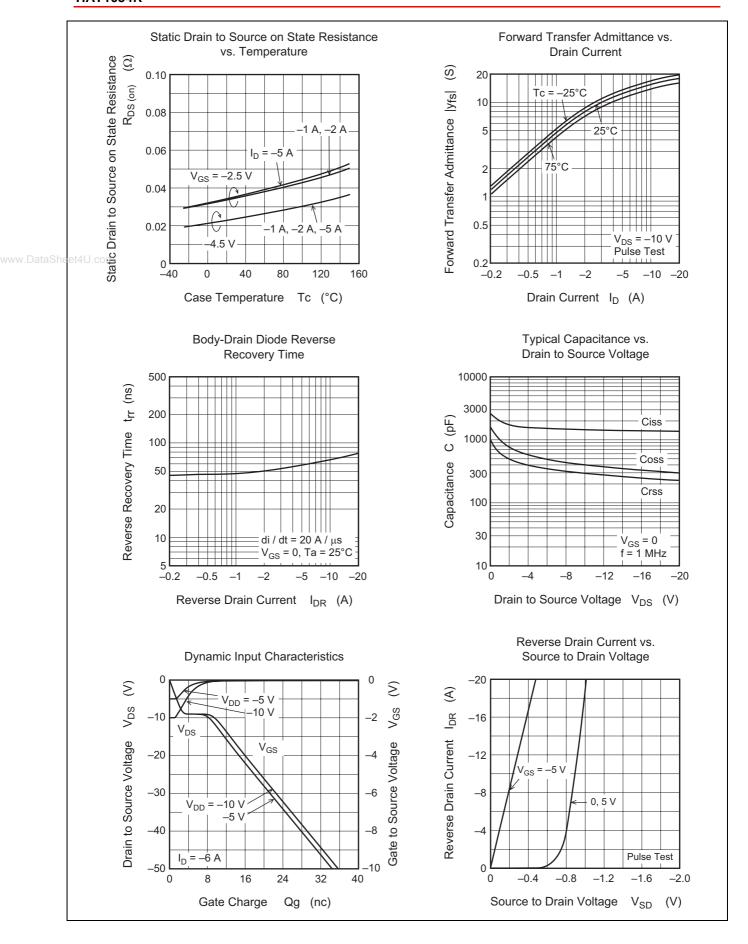
 $(Ta = 25^{\circ}C)$ 

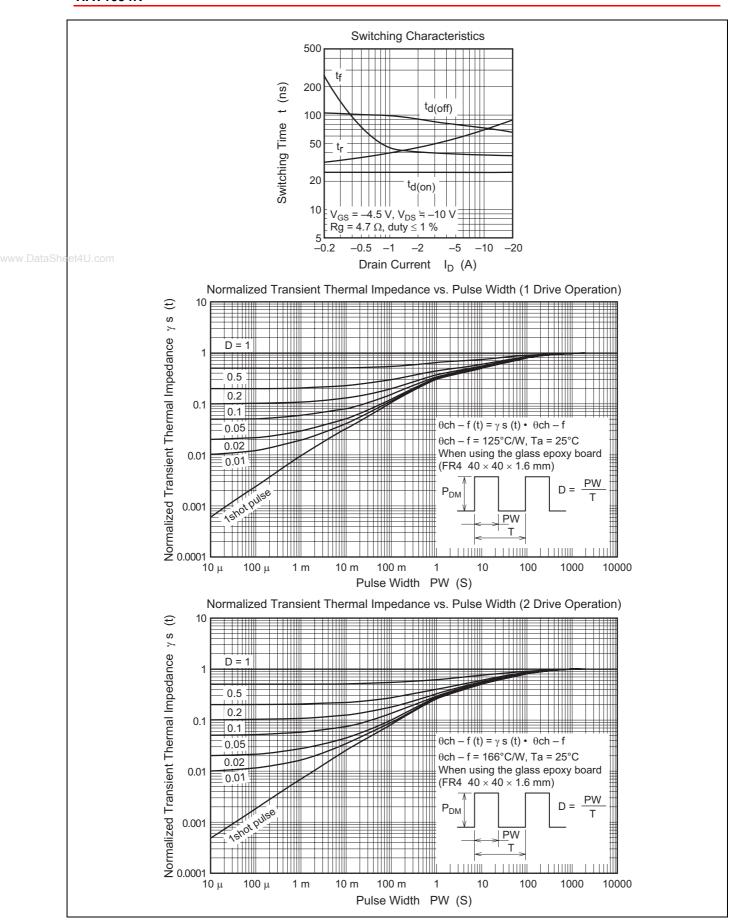
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR) DSS</sub>	-20		_	<b>V</b>	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V <sub>(BR) GSS</sub>	±12	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	-1	μΑ	$V_{DS} = -20 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS (off)</sub>	-0.4	_	-1.4	V	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$
Static drain to source on state	R <sub>DS (on)</sub>	_	24	30	mΩ	$I_D = -3 \text{ A}, V_{GS} = -4.5 \text{ V}^{\text{Note 4}}$
resistance	R <sub>DS (on)</sub>	_	35	50	mΩ	$I_D = -3 \text{ A}, V_{GS} = -2.5 \text{ V}^{\text{Note 4}}$
Forward transfer admittance	y <sub>fs</sub>	6	10	_	S	$I_D = -3 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note 4}}$
Input capacitance	Ciss	_	1550	_	pF	$V_{DS} = -10 \text{ V}$
Output capacitance	Coss	_	400	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	300	_	pF	f = 1 MHz
Total gate charge	Qg	_	18	_	nC	$V_{DD} = -10 \text{ V}$
Gate to source charge	Qgs	_	3	_	nC	$V_{GS} = -4.5 \text{ V}$
Gate to drain charge	Qgd	_	6.5	_	nC	$I_D = -6 A$
Turn-on delay time	t <sub>d (on)</sub>	_	25	_	ns	$V_{GS} = -4.5 \text{ V}, I_D = -3 \text{ A},$
Rise time	t <sub>r</sub>	_	50	_	ns	V <sub>DD</sub> ≅ −10 V
Turn-off delay time	t <sub>d (off)</sub>	_	85	_	ns	$R_L = 3.3 \Omega$
Fall time	t <sub>f</sub>	_	40	_	ns	$Rg = 4.7 \Omega$
Body-drain diode forward voltage	$V_{DF}$	_	-0.85	-1.10	V	$I_F = -6 \text{ A}, V_{GS} = 0^{\text{Note 4}}$
Body-drain diode reverse recovery time	t <sub>rr</sub>	_	60	_	ns	$I_F = -6 \text{ A}, V_{GS} = 0$
						di <sub>F</sub> /dt = 20 A/μs

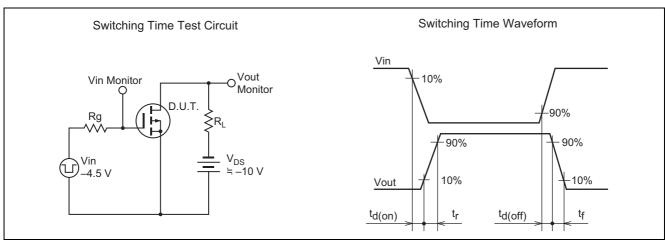
Note: 4. Pulse test

#### **Main Characteristics**



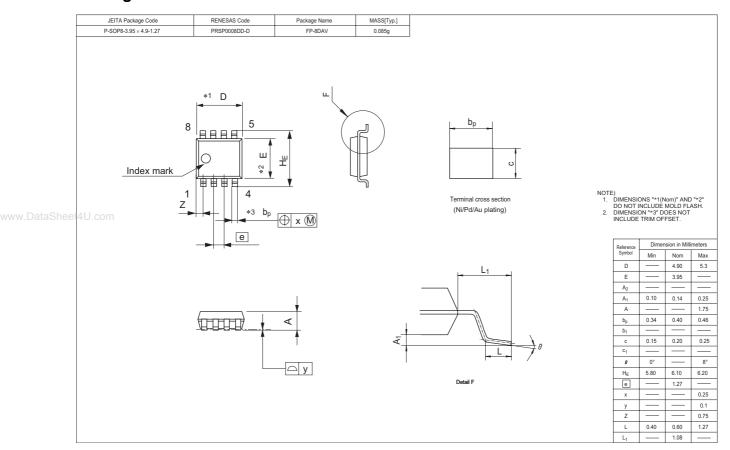






www.DataSheet4U.com

## **Package Dimensions**



## **Ordering Information**

Part Name	Quantity	Shipping Container		
HAT1054R-EL-E	2500 pcs	Taping		

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